

215648US-0PCT

JC17 Rec'd PCT/PTO 07 NOV 2001
*Pre A*IN THE UNITED STATES PATENT & TRADEMARK OFFICEIN RE APPLICATION OF :
MASAKAZU FURUKAWA ET AL

ATTN: APPLICATION DIVISION

SERIAL NO: NEW U.S. PCT APPLN
(Based on PCT/JP00/02749) :
FILED: HEREWITH :
FOR: HOT PLATE AND PROCESS FOR :
PRODUCING THE SAMEPRELIMINARY AMENDMENTASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

IN THE CLAIMS

Please amend the claims as shown on the marked-up copy following this amendment to read as follows:

3. (Amended) The hot plate according to claim 1, wherein the thickness of said resistance element is from 0.5 to 500 μm .

5. (Amended) The hot plate according to claim 1, wherein said insulating substrate is at least one kind selected from a nitride ceramic, a carbide ceramic and a resin.

6. (Amended) The hot plate according to claim 1, wherein said resistance element is made of scaly noble metal powder.